Research Article
Postannealing Effect at Various Gas Ambients on Ohmic Contacts of Pt/ZnO Nanobilayers toward Ultraviolet Photodetectors

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This paper describes a fabrication and characterization of ultraviolet (UV) photodetectors based on Ohmic contacts using Pt electrode onto the epitaxial ZnO (0002) thin film. Plasma enhanced chemical vapor deposition (PECVD) system was employed to deposit ZnO (0002) thin films onto silicon substrates, and radio-frequency (RF) magnetron sputtering was used to deposit Pt top electrode onto the ZnO thin films. The as-deposited Pt/ZnO nanobilayer samples were then annealed at 450°C in two different ambients (argon and nitrogen) to obtain optimal Ohmic contacts. The crystal structure, surface morphology, optical properties, and wettability of ZnO thin films were analyzed by X-ray diffraction (XRD), field emission scanning electron microscopy (FE-SEM), atomic force microscopy (AFM), photoluminescence (PL), UV-Vis-NIR spectrophotometer, and contact angle meter, respectively. Moreover, the photoconductivity of the Pt/ZnO nanobilayers was also investigated for UV photodetector application. The above results showed that the optimum ZnO sample was synthesized with gas flow rate ratio of 1:3 diethylzinc [DEZn, Zn(C2H5)2] to carbon dioxide (CO2) and then combined with Pt electrode annealed at 450°C in argon ambient, exhibiting good crystallinity as well as UV photo responsibility.

1. Introduction

It is known that only ultraviolet A (UVA) with wavelength ranging from 320 to 400 nm of the sunlight can pass through the atmosphere and reach the earth’s surface. The UVA might harm human’s skin, and therefore it is an important issue to develop ultraviolet (UV) photodetector in the UVA-wavelength region. Many wide band gap materials such as GaN, AlGaN, ZnSe, and diamond have been used for the UV photodetector applications [1–6]. Compared with the above materials, zinc oxide (ZnO) is considered as potential candidate compound for UV detector owning to its wide direct band gap of 3.37 eV at room temperature, relatively large exciton binding energy of 60 meV, nontoxicity, outstanding thermal and chemical stability, and low power threshold for optical pumping as well as rich raw materials [7, 8]. However, due to the challenge of p-type doping in ZnO structures, fabrication of ZnO p-n junction based on UV photodetector is still under development [9]. Hence, either Ohmic contact based photoconductive type or Schottky contact based photovoltage type of ZnO metal-semiconductor-metal (MSM) is another way to develop UV photodetector [10, 11]. Comparing the differences between Ohmic and Schottky contact types, the Ohmic contact based photoconductive type device is typically more easily made and more understood. High quality ZnO films with good Ohmic contact are essential for fabricating high performance UV photodetector, which is based on a strong oxygen chemisorption and photodesorption mechanism on both the grain boundaries and surface [12, 13].

Over the past few decades, various growth techniques of stoichiometric ZnO phase have been used, such as thermal
evaporation, radio-frequency (RF) magnetron sputtering, pulsed laser deposition (PLD), molecular beam epitaxy (MBE), metal organic chemical vapor deposition (MOCVD), and plasma enhanced chemical vapor deposition (PECVD) [14–18]. Among these techniques, the PECVD system is a promising one for fabricating large-area uniform ZnO thin films in order to apply for future electronic devices and sensors because it has numerous advantages, namely, low cost and high growth rates. On the other hand, the plasma bombardment can increase the density of thin films and enhance the ion decomposition reaction rate, which was used to improve the thin films crystallinity [19]. Thus, the PECVD system was used to grow ZnO thin films onto silicon substrates with various gas flow rate ratios of diethylzinc (DEZn) to carbon dioxide (CO$_2$) and at a fixed temperature of 400$^\circ$C in this presented work. On the other hand, there are some reports on Ohmic contacts of ZnO-based devices using ZrB$_2$/Pt/Au, Ti/Au, Pt/Nil/Au or Ni/Pt, and so forth as the contact-electrode metals [20–23]. Due to high thermal and electrical conductivity, good temperature and chemical stability, platinum (Pt) is a better material for electrode application. Herein, Pt as electrode material of Ohmic contact was used to deposit onto ZnO films by RF magnetron sputtering.

However, there is little report on the effects of post-annealing on electrical properties of Pt/ZnO contacts through deposition of epitaxial ZnO films onto Si substrates. In addition, Pt metal forms an Ohmic contact with n-type ZnO. Thus, ZnO/Pt heterostructures could offer a range of advantages for the realization of optoelectronic devices such as UV photodetectors. The electrical properties of Pt/ZnO film contacts are a key to the use of ZnO films in such devices, and a study of such properties is vital in determining the potential of such heterostructure for device applications. The main aim of the present paper is to systematically study the effects of different gas flow rate ratios of DEZn to CO$_2$ on crystalline quality and uniformity of epitaxial ZnO films, modification of native defects in ZnO films, and the electrical properties of Pt/ZnO nanobilayer films contact and explore the potential application of UV photodetector. This presented study was separated into two parts. The first part was the synthesis of epitaxial ZnO films on silicon substrates by PECVD system with various CO$_2$ flow rates. The second part was the deposition of Pt to form Ohmic contacts onto ZnO films by RF magnetron sputtering. The standard lift-off process was used to fabricate the UV detectors with interdigitated electrodes. Furthermore, the as-prepared UV devices were postannealed via rapid thermal annealing (RTA) at various temperatures and with different ambient (argon and nitrogen) to obtain Ohmic contacts. The crystalline structure, surface morphology, optical properties, and wettability of ZnO thin films were investigated by X-ray diffraction (XRD), field emission scanning electron microscopy (FE-SEM), atomic force microscopy (AFM), room temperature photoluminescence spectra (PL), and contact angle meter, respectively. $I$-$V$ curves were used to determine the Ohmic contacts efficiency. Finally, the photoresponse of the devices at room temperature in air was discussed.

### 2. Experimental Procedures

ZnO thin films were deposited on silicon (100) substrates employing PECVD system, which used diethylzinc [DEZn, Zn (C$_2$H$_5$)$_2$] and carbon dioxide (CO$_2$) gas as precursors for supplying zinc and oxygen sources, respectively. The 15 cm diameter showerhead served as the top electrode and was connected with a 13.56 MHz radio-frequency (RF) power that could generate the plasma through a match network. The bottom electrode was grounded and served as the sample stage. The distance between top electrode and bottom electrode was fixed at 30 mm. All the 10 mm × 10 mm silicon substrates were cleaned by using acetone, alcohol, and de-ionized water, for half an hour in an ultrasonic cleaner. The system was evacuated to base pressure at 3 × 10$^{-6}$ Torr by rotary pump and turbo pump, respectively. Subsequently, the argon plasma induced from RF generator in the chamber was used to clean the substrate surface oxide layer for 15 minutes. The working pressure of the chamber was kept at 6 Torr and RF power was fixed at 70 W, and the substrates were heated at 400$^\circ$C during ZnO thin films growth. A series of ZnO thin films with the fixed thickness of 500 nm were synthesized on the silicon substrates with different gas flow rate ratios of DEZn to CO$_2$ (1:1, 1:2, and 1:3). Crystalline structure of ZnO thin films was characterized by X-ray diffraction (XRD) with Cu K$_\alpha$ radiation ($\lambda = 1.54$ Å). The surface morphology of ZnO films was observed by field emission scanning electron microscopy (FE-SEM). The surface topography and roughness of thin films were further analyzed from the atomic force microscope (AFM). Photoluminescence (PL) was carried out at room temperature to study the optical properties of the ZnO thin films through a He-Cd laser (325 nm). The optical transmittance was recorded by using a MP100-ME UV-Vis-NIR spectrophotometer and the wettability of ZnO thin films was also measured by contact angle meter, respectively.

As for UV photodetector fabrication, the interdigitated Pt (thickness ~100 nm) Ohmic contact electrode was fabricated via conventional UV lithography, wet-etching methods, and RF magnetron sputtering to form finger-pattern onto epitaxial ZnO (0002) films. The finger-pattern of the contact electrodes was 30 μm wide (14 pairs) and had an interelectrode spacing of 150 μm. The photo image of interdigitated electrode is shown in Figure 1. In order to form Ohmic contacts, ZnO and Pt would be directly connected. Unfortunately, the work functions of the above materials are not close, 5.65 eV and 4.3 eV, respectively. For the sake of overcoming mismatch of work functions, the rapid thermal annealing (RTA) was used instead to form Ohmic contacts. Postannealing was performed at different temperatures between 350$^\circ$C and 550$^\circ$C for 10 min at argon and nitrogen ambients, respectively. The Ahilent P1456S measurement system combined with a 38 mW/cm$^2$ mercury arc lamp (Hamamatsu-deuterium L2D2) was used as the UV (365 nm) light source to measure current-voltage ($I$-$V$) characteristic and photoresponse, respectively.
to CO$_2$. During the ZnO phase growth, CO$_2$ concentration played an important role due to the oxygen ions originating from CO$_2$ which were relatively low in the chamber when gas flow rate value was 1:1, which indicated the zinc ions had no sufficient chance to react with oxygen ions to form a high property ZnO phase. Consequently, with the increasing gas flow rate of CO$_2$, the diffraction peak of the ZnO (0002) gradually became sharp and narrow. The strongest of (0002) diffraction peaks was obtained at the gas flow rate value of 1:3 (DEZn to CO$_2$). The inset in Figure 2 showed the full width at half maximum (FWHM) of ZnO (0002) diffraction peak, which was determined by X-ray rocking curve (ω) scan. The FWHM of the (0002) diffraction peak of the ZnO thin film with gas flow rate ratio of 1:3 shows an extremely small value of 0.1694°, while the ZnO thin films with gas flow rate ratios of 1:2 and 1:1 exhibit relatively large values of 0.1720° and 0.1742°, respectively. The X-ray rocking curve mostly demonstrates the degree of the tilt component, and the tilt itself is related to screw-type threading dislocations. Therefore, the optimum synthesized condition of epitaxial ZnO (0002) film with the gas flow rate ratio of DEZn to CO$_2$ is 1:3 in this presented work. This parameter can effectively reduce screw dislocation density with the highest crystalline quality of stoichiometric ZnO thin film.

In-plane surface morphology of epitaxial ZnO (0002) films was observed by FE-SEM as shown in Figures 3(a)–3(c). PECVD system is a promising technique for synthesizing ZnO phase by using DEZn and CO$_2$ mixtures. Also, it is especially easy to break the oxygen–oxygen bonds from CO$_2$ to react with zinc atoms from DEZn, leading to the compact surface [25]. The SEM top view images clearly show that all of the ZnO thin films have smoothability of compact surfaces with curvature boundary and are densely packed with spherical grains. Additionally, the thickness of all ZnO thin films is about 500 nm with self-assembled columnar structures along the c-axis [0001] determined by cross section images in the inset of Figures 3(a)–3(c). From the AFM surface topography images as shown in Figures 3(d)–3(f), the average surface roughness values (root-mean-square (RMS)) with the gas flow rate ratios of DEZn to CO$_2$ (1:1, 1:2, and 1:3) showed 6.46 nm, 6.82 nm, and 8.97 nm (1 μm × 1 μm), respectively. The above results indicated that the epitaxial ZnO (0002) thin film could provide a suitable nanometer-scale smoothness topography for the subsequent deposition of Pt top electrode onto its surface.

Figure 4 illustrates the room temperature PL spectrum. The spectra mainly consist of two emission bands: a near-band-edge (NBE) emission and a broad defect-related visible emission (500–700 nm). The result exhibits that the main emission bands intensity is closely related to the gas flow rate ratios of DEZn to CO$_2$. All the epitaxial ZnO (0002) thin films show a strong NBE emission band which is attributed to the recombination of free-excitons through an exciton-exciton collision process [26]. However, with varying the gas flow rate ratios of DEZn to CO$_2$ (ranging from 1:3 to 1:1), the intensity of NBE emission became weaker with slight red shift, accompanied with the visible emission band became stronger. In general, the lattice distortions and localization of charges from interface defects or point defects may cause

### 3. Results and Discussion

#### 3.1. Material Optimization

Figure 2 shows the X-ray diffraction (XRD) patterns for the ZnO thin films synthesized by PECVD system with different gas flow rate ratios of DEZn to CO$_2$. The XRD patterns of all ZnO samples exhibit only a strong c-axis (0002) diffraction peak located at 34.4°, indicating that epitaxial thin films possess a hexagonal wurtzite structure. The lowest surface energy of the (0002) basal plane in ZnO leads to a preferred orientation in the [0001] direction; as a result, ZnO thin films have been grown with c-axis orientation onto epitaxial substrate under optimum growth conditions [24]. However, the crystalline quality of the ZnO thin films is related to the gas flow rate ratio of DEZn...
the red shift of emission band [27]. On the other hand, the visible emission band is generally referred to the impurities and various structural defects in the ZnO thin films such as zinc interstitial and oxygen vacancy [28]. When thin film quality of ZnO was improved via providing sufficient oxygen ions, the density of defect was reduced and resulted in a strong intensity of NBE emission with blue shift in the UV region and the visible emission gradually disappeared. According to the above results, the epitaxial ZnO (0002) thin film grown under the optimum gas flow rate ratio of 1:3 (DEZn to CO₂)

Figure 3: In-plane and out-of-plane field emission scanning electron microscopy images for ZnO (0002) thin films synthesized with gas flow rate ratios of DEZn to CO₂ of (a) 1:1, (b) 1:2, and (c) 1:3; the corresponding AFM images (1 × 1 μm²) with gas flow rate ratios of (d) 1:1, (e) 1:2, and (f) 1:3, respectively.
is a promising approach for application in the realization of ultraviolet (UV) photon detectors.

3.2. UV Photodetector Fabrication and Responsivity. Current-voltage (I-V) characteristics of the Pt/ZnO nanobilayer devices annealed at various temperatures (350°C, 450°C, and 550°C) in argon ambience for 10 min are shown in Figure 5(a). Only an obvious linear behavior could be observed for the Pt/ZnO device annealed at 450°C, which indicated that the high quality Ohmic contact has been achieved at the Pt/ZnO interface. The device was further annealed at 450°C in nitrogen ambience for 10 min, and corresponding I-V characteristics of device were as shown in Figure 5(b). The Ohmic effect of Pt/ZnO device annealed in nitrogen ambience shows better performance than that of annealing in argon ambience. The schematic diagram for the UV photodetector device is shown in the inset of Figure 5(a), in which interdigitated Pt electrode was deposited onto the optimal ZnO (0002) thin films. The formation of thermally stable and low resistance Ohmic contacts is critical to realizing high quality ZnO-based optoelectronic devices. The high contact resistance between semiconductor and metal gives rise to the degradation of optoelectronic device performance through thermal stress and contact failure. Thermally stable and low contact resistance can be achieved either by performing surface modification to reduce the semiconductor-metal barrier height or by increasing the effective carrier concentration of the surface, which allow an increase in carrier tunnelling probability. Hence, Ohmic contact metallization should be one of the main purposes in improving the optoelectronic device performance. However, the formation of Ohmic contact method in ZnO-based optoelectronic device has not been investigated extensively, and it is limited mostly to n-type contacts.

Figure 6 shows the dark current and photocurrent characteristics of the UV photodetector as a function of bias voltage ranged from −5V to 5V for Pt/ZnO thin films structure. It can be seen that only the Pt/ZnO device annealed in argon ambience exhibits the photoconductive behavior as shown in Figure 6(a). Furthermore, both the dark and photo currents increase linearly with increasing bias voltage, indicating that the Pt top electrode forms the Ohmic contact onto the ZnO (0002) thin film. Without UV light illumination, the observed dark current was about 4.8 mA at a 5 V bias. When the Pt/ZnO device was illuminated under a 365 nm wavelength with the energy of 38 mW/cm², the photocurrent was approximately 36 mA at a 5 V bias, indicating that the UV photodetector composed of Pt/ZnO nanobilayer films structure has high photosensitivity. The origin of photocurrent by the adsorption and desorption of oxygen molecules has been highly considered [29, 30]. Before UV illumination, the ZnO films were exposed to air in the dark and oxygen molecules, which could be adsorbed on the ZnO surface in order to extract free electrons according to the following:

\[
\text{O}_2 (g) + e^- \rightarrow \text{O}_2^- (\text{ad}) \tag{1}
\]

\[
\text{O}_2 (g) + 2e^- \rightarrow \text{O}_2^{2-} (\text{ad}) \tag{2}
\]

The negative oxygen ions adhered to the surface and created a depletion of electron at the grain boundaries of ZnO thin films. These negative oxygen ions cannot contribute to the conductivity to the thin film, which makes the thin film produce a low conductive surface. However, upon exposure to UV irradiation, the negative oxygen ions can form neutral by capturing a photogenerated hole, which is expressed in the following:

\[
\text{H}^+ + \text{O}_2^- (\text{ad}) \rightarrow \text{O}_2 (g) \tag{3}
\]

\[
2\text{H}^+ + \text{O}_2^{2-} (\text{ad}) \rightarrow \text{O}_2 (g) \tag{4}
\]

The wavelength of UV light ~365 nm closely matches the band gap of ZnO ~3.37 eV; high energy photons get absorbed by the ZnO layer and generate electron-hole pairs consequently. The photogenerated holes recombine with electrons of the adsorbed oxygen ions through surface recombination and simultaneously release oxygen atoms from the surface. As a result, lowering of depletion layer height at the grain boundary region takes place. These accumulated unpaired electrons in the conduction band of ZnO will contribute to increasing the photoconductivity of the ZnO-based UV devices.

The dark current and photocurrent characteristics of UV photodetector composed of Pt/ZnO nanobilayer films structure annealed in nitrogen are also shown in Figure 6(b). The I-V characteristics of dark and photo-currents are overlapping, which means the device has no photosresponsivity. When the Pt/ZnO films structure was annealed in nitrogen ambience, the nitrogen atoms might not only act as acceptors and form a doped layer near the surface of the ZnO thin film but also produce a thin nitride layer. The increase in the carrier concentration with the nitride layer can lower the barrier
height of the Ohmic contact, which was formed between the Pt electrode and ZnO thin film. It will lead to higher current value with lower resistance compared with the device annealed in argon ambience. At the same time, the nitride layer onto the ZnO thin film surface would directly prevent UV light irradiation for the surface of ZnO thin film. Hence, the aforementioned electric field generated from the depletion region of the ZnO thin film surface will be forbidden. The UV photodetector device composed of Pt/ZnO bilayer films structure annealed in nitrogen ambience is not suitable for UV sensor owing to the lack of photoconductivity.

The reproducibility of the photodetector device annealed in argon ambience was tested by repeatedly switching UV light on and off for the same time intervals as shown in Figure 7. When the device was illuminated by the UV light, the current increased sharply and remained in a stable state. After the removal of light source, the device recovered to an original level. The response and recovery times of the device...
Figure 7: Photocurrent as a function of measured time obtained by switching on and off UV illumination on the photodetector composed of Pt/ZnO nanobilayer films structure.

Contact angle = 98.13°, 102.77°, and 111.32°, respectively.

Figure 8: Water contact angle images accompanied with the measured values for the ZnO (0002) thin films synthesized at different gas flow rate ratios of 1:1, 1:2, and 1:3.

are 2 s and 1.5 s, respectively, as shown in the inset of Figure 7. The result shows great reproducibility and good stability for the UV photodetector device at least 3 times without change. The quick response and stability obtained from the device are useful for UV photodetector application.

Figure 9: Optical transmittance spectra for the ZnO (0002) thin film synthesized at gas flow rate ratio of 1:3 compared with the bare glass substrate.

On the other hand, the wettability of epitaxial ZnO (0002) thin films was characterized by a contact angle goniometer (Pentad FTA 125). If the water contact angle with the surface is smaller than 90°, then the surface is termed as hydrophilic. On the contrary, if the water contact angle with the surface is greater than 90° then the surface is termed as hydrophobic. Figure 8 shows the water contact angle values of ZnO films with various gas flow rate ratios of 1:1, 1:2, and 1:3 are 98.13°, 102.77°, and 111.32°, respectively. In general, the high hydrophobic property was formed by modifying surfaces with low surface energy coating [31] or increasing surface roughness [32]. In our presented work, the measured results indicated that the surface of ZnO thin films was more hydrophobic with increasing surface roughness. Compared with the water contact angle values of ZnO films with various gas flow rate ratios, the largest surface roughness was obtained with the gas flow rate ratio of 1:3 (8.97 nm), leading to the largest hydrophobicity consistent with the observed results from Figure 3.

Additionally, in order to investigate the transparency of epitaxial ZnO (0002) thin film, the ZnO (0002) thin film was also synthesized onto glass substrates for future high-transmittance ZnO-based optoelectronic devices. The transmittance spectrum showed that ZnO (0002) thin film exhibits high transmittance in the 400–900 nm range and with higher than 80% visible transmittance as shown in Figure 9.

4. Conclusions

Epitaxial ZnO (0002) thin film was first synthesized on silicon substrate with gas flow rate ratio of 1:3 (DEZn to CO₂) by PECVD system, which exhibited good crystallinity, low surface roughness, high optical properties, and good visible
transparency. The Ohmic contacts were formed between Pt top electrode and ZnO thin films together annealed at 450°C in argon and nitrogen ambients for 10 min. However, the UV photodetector composed of Pt/ZnO nanobilayers structure only annealed in argon ambience shows a lower dark current of 4.8 mA and a higher photocurrent of 36 mA at 5 V bias voltage. Therefore, a simple method is presented which used Pt contact electrode onto epitaxial ZnO (0002) thin film and is suitable for potential device application of UV photodetector, showing a good Ohmic contacts behavior as well as UV photosensitivity.

Conflict of Interests

The authors declare that there is no conflict of interests regarding the publication of this paper.

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